

## CMOS 8-bit Single Chip Microcomputer

### Description

The CXP83412/83416 and CXP83413/83417 are a CMOS 8-bit microcomputer which consists of A/D converter, serial interface, timer/counter, time base timer, 32kHz timer/counter, LCD controller/driver, remote control receiving circuit and PWM output, as well as basic configurations like 8-bit CPU, ROM, RAM and I/O port. They are integrated into a single chip.

Also CXP83412/83416 and CXP83413/83417 sleep/stop function which enables to lower power consumption.

### Features

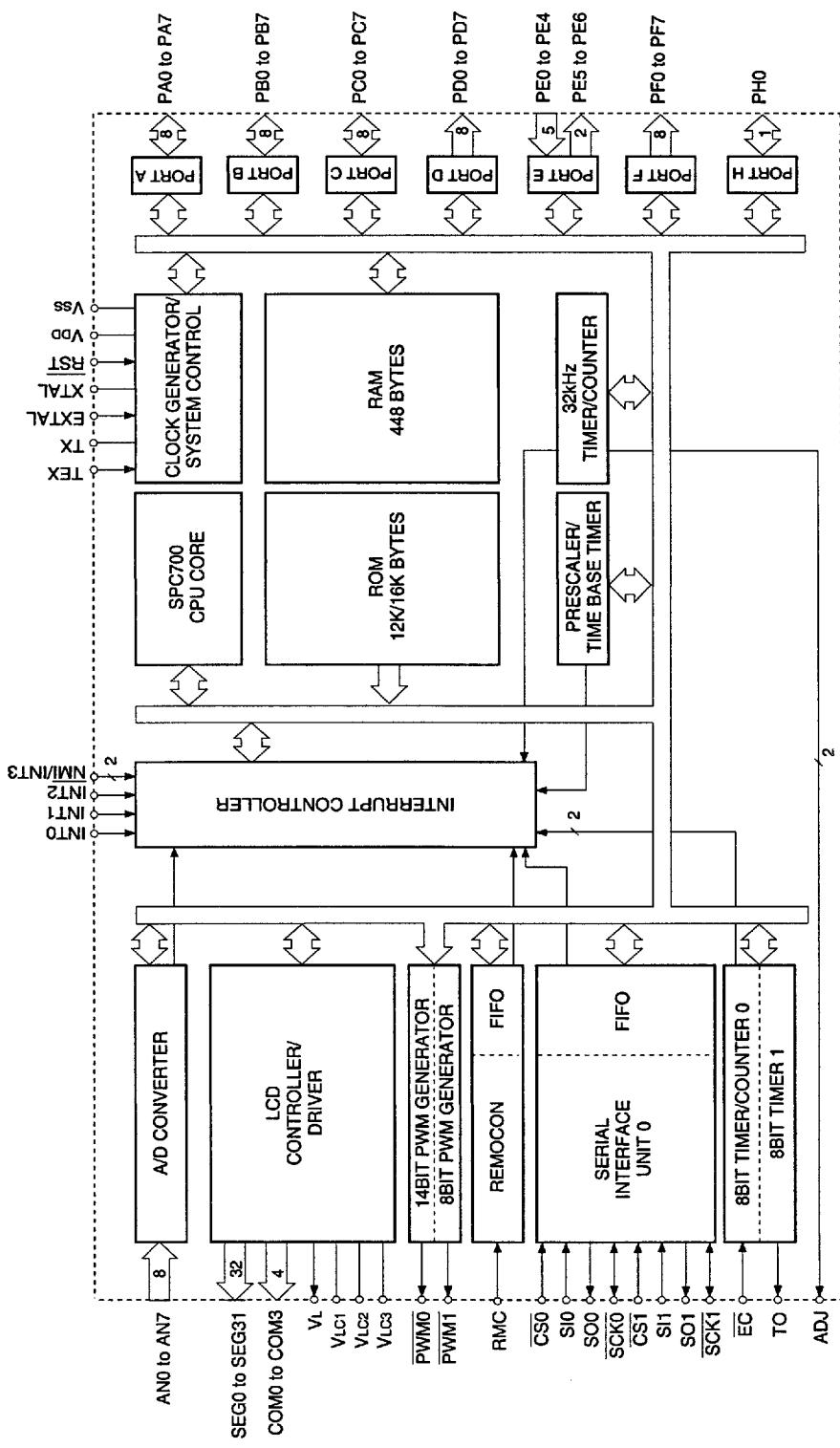
- A wide instruction set (213 instructions) which covers various types of data
  - 16-bit arithmetic/multiplication and division/ Boolean bit operation instructions
- Minimum instruction cycle
  - 400ns at 10MHz operation (4.5 to 5.5V)
  - 122 $\mu$ s at 32kHz operation (2.7 to 5.5V)
- Incorporated ROM capacity
  - 12K bytes (CXP83412, 83413)
  - 16K bytes (CXP83416, 83417)
- Incorporated RAM capacity
  - 448 bytes (LCD display data area included)
- Peripheral functions
  - A/D converter
    - 8 bits, 8 channels, successive approximation system (Conversion time: 32 $\mu$ s/10MHz)
  - Serial interface
    - Incorporated 8-bit and 8-stage FIFO
    - (1 to 8 bytes auto transfer), 1 circuit 2 channels
  - Timer
    - 8-bit timer, 8-bit timer/counter, 19-bit time base timer, 32kHz timer/counter
  - LCD controller/driver
    - Maximum 128 segments display possible (During 1/4 duty)
    - 4 common outputs, 32 segment outputs
    - Display method: Static, 1/2, 1/3 and 1/4 duty
    - Bias method: 1/2 and 1/3 bias
  - Remote control receiving circuit
  - PWM output
- Interruption
- Standby mode
- Package
  - 80-pin plastic QFP/LQFP
- Piggyback/evaluator
  - CXP83400

### Structure

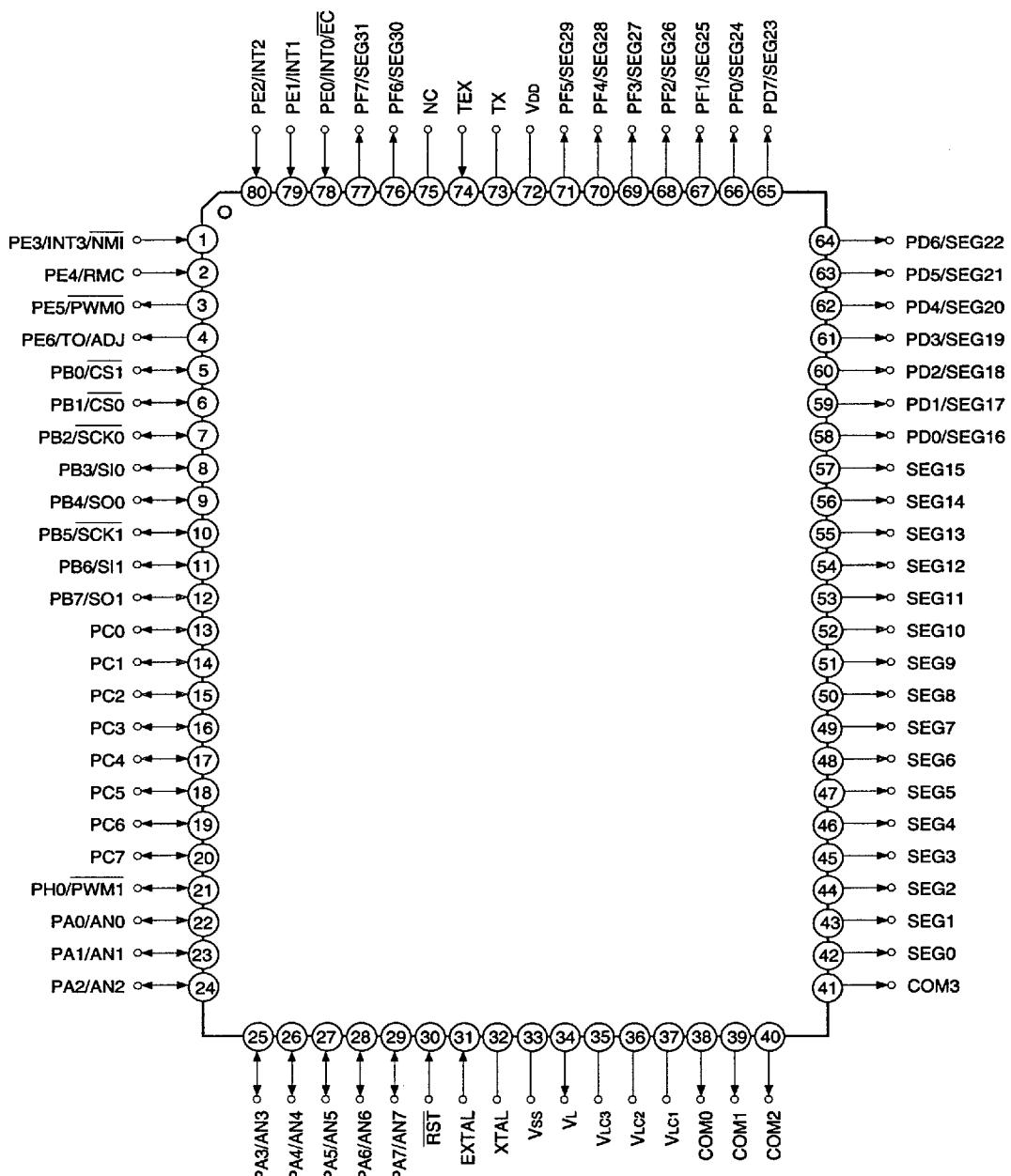
#### Silicon gate CMOS IC

Sony reserves the right to change products and specifications without prior notice. This information does not convey any license by any implication or otherwise under any patents or other right. Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits.

## Block Diagram

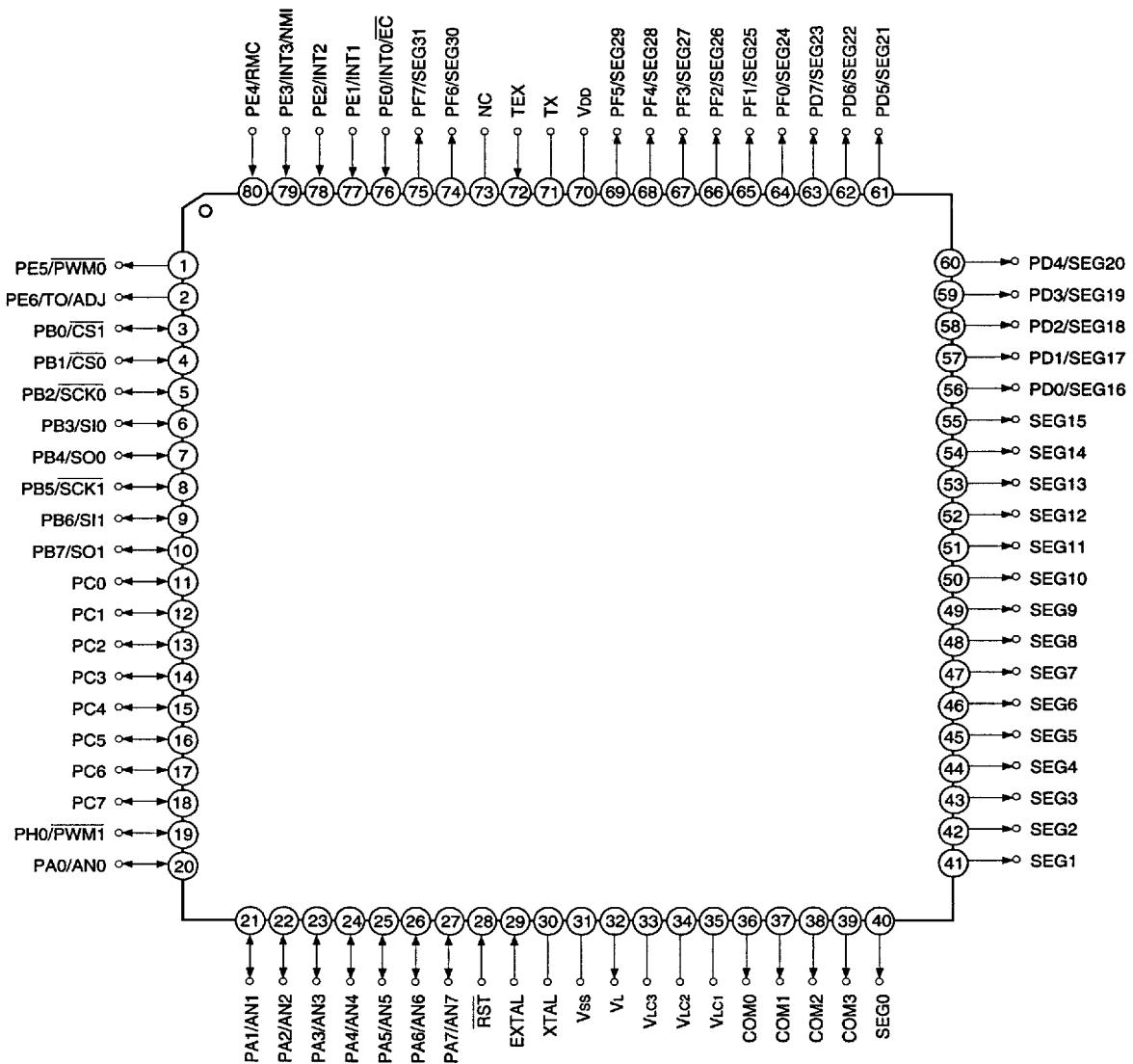


## Pin Assignment (Top View) CXP83412/83416 (QFP package)



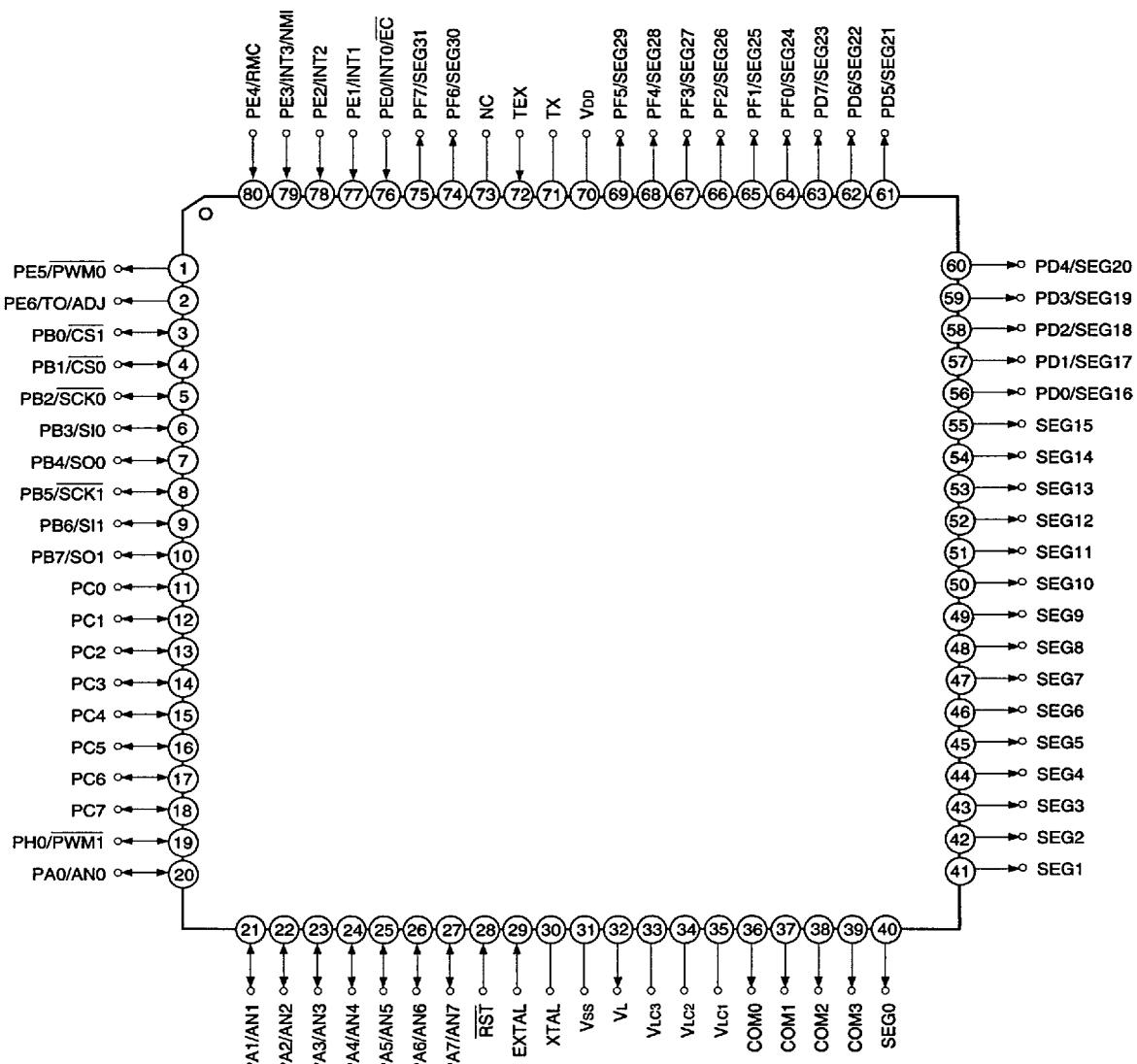
Note) NC (Pin 75) is always connected to VDD.

## Pin Assignment (Top View) CXP83412/83416 (LQFP package)



**Note)** NC (Pin 73) is always connected to VDD.

## Pin Assignment (Top View) CXP83413/83417 (QFP package)



**Note)** NC (Pin 73) is always connected to Vdd.

**Pin Description**

Symbol	I/O	Functions	
PA0/AN0 to PA7/AN7	I/O/Analog input	(Port A) 8-bit I/O port. I/O can be set in a unit of single bits. Incorporation of pull-up resistor can be set through the software in a unit of 4 bits. (8 pins)	Analog inputs to A/D converter. (8 pins)
PB0/CS1	I/O/Input	(Port B) 8-bit I/O port. I/O can be set in a unit of single bits. Incorporation of pull-up resistor can be set through the software in a unit of 4 bits. (8 pins)	Chip select input for serial interface (CH1).
PB1/CS0	I/O/Input		Chip select input for serial interface (CH0).
PB2/SCK0	I/O/I/O		Serial clock I/O (CH0).
PB3/SI0	I/O/Input		Serial data input (CH0).
PB4/SO0	I/O/Output		Serial data output (CH0).
PB5/SCK1	I/O/I/O		Serial clock I/O (CH1).
PB6/SI1	I/O/Input		Serial data input (CH1).
PB7/SO1	I/O/Output		Serial data output (CH1).
PC0 to PC7	I/O	(Port C) 8-bit I/O port. I/O can be set in a unit of single bits. Capable of driving 12mA sync current. Incorporation of pull-up resistor can be set through the software in a unit of 4 bits. (8 pins)	
PE0/INT0/ <u>EC</u>	Input/Input/Input	(Port E) 7-bit port. Lower 5 bits are for inputs; upper 2 bits are for outputs. (7 pins)	External event inputs for timer/counter.
PE1/INT1	Input/Input		External interruption request input. (4 pins)
PE2/INT2	Input/Input		Non-maskable intrruption request input.
PE3/INT3/ <u>NMI</u>	Input/Input/Input		Remote control receiving circuit input.
PE4/RMC	Input/Input		14-bit PWM output.
PE5/PWM0	Output/Output		Rectangular wave output for 8-bit timer/counter and 32kHz oscillation frequency divider output.
PE6/TO/ADJ	Output/Output/Output		
PH0/PWM1	I/O/Output	(Port H) 1-bit I/O port. Incorporation of pull-up resistor can be set through the software. (1 pin)	8-bit PWM output.

Symbol	I/O	Functions	
PD0/SEG16 to PD7/SEG23	Output/Output	(Port D) 8-bit output port. (8 pins)	LCD segment signal output. (16 pins)
PF0/SEG24 to PF7/SEG31	Output/Output	(Port F) 8-bit output port. (8 pins)	
SEG0 to SEG15	Output	LCD segment signal output.	
COM0 to COM3	Output	LCD common signal output.	
V <sub>Lc1</sub> to V <sub>Lc3</sub>		LCD bias power supply.	
V <sub>L</sub>	Output	Control pin to cut off the current flowing to external LCD bias resistor during standby.	
EXTAL	Input	Crystal connectors for system clock oscillation. When the clock is supplied externally, input to EXTAL; opposite phase clock should be input to XTAL.	
TEX	Input	Crystal connectors for 32kHz timer/counter clock generation circuit. For usage as event counter, connect clock oscillation source to TEX, and leave TX open.	
TX	Output		
RST	Input	Low-level active, system reset.	
NC		NC. Under normal operating conditions, connect to V <sub>DD</sub> .	
V <sub>DD</sub>		Positive power supply.	
V <sub>SS</sub>		GND.	

## I/O Circuit Format for Pins

Pin	Circuit format	When reset
PA0/AN0 to PA7/AN7  8 pins	<p>Port A</p> <p>Pull-up resistor "0" when reset</p> <p>Port A data</p> <p>Port A direction "0" when reset</p> <p>Data bus</p> <p>RD (Port A)</p> <p>Port A input selection "0" when reset</p> <p>Input multiplexer</p> <p>A/D converter</p> <p>* Pull-up resistors approx. 100kΩ</p>	Hi-Z
PB0/CS1 PB1/CS0 PB3/SI0 PB6/SI1  4 pins	<p>Port B</p> <p>Pull-up resistor "0" when reset</p> <p>Port B data</p> <p>Port B direction "0" when reset</p> <p>Data bus</p> <p>RD (Port B)</p> <p>CS1 CS0 SI0 SI1</p> <p>Schmitt input</p> <p>* Pull-up transistors approx. 100kΩ</p>	Hi-Z
PB2/SCK0 PB5/SCK1  2 pins	<p>Port B</p> <p>Pull-up resistor "0" when reset</p> <p>SCK OUT</p> <p>Output enable</p> <p>Port B output selection "0" when reset</p> <p>Port B data</p> <p>Port B direction "0" when reset</p> <p>Data bus</p> <p>RD (Port B)</p> <p>SCK in</p> <p>Schmitt input</p> <p>* Pull-up transistors approx. 100kΩ</p>	Hi-Z

Pin	Circuit format	When reset
PB4/SO0 PB7/SO1  2 pins	<p>Port B</p> <p>* Pull-up transistors approx. 100kΩ</p>	Hi-Z
PC0 to PC7  8 pins	<p>Port C</p> <p>*1 Large current 12mA *2 Pull-up transistors approx. 100kΩ</p>	Hi-Z
PE0/INT0/EC PE1/INT1 PE2/INT2 PE3/INT3/NMI PE4/RMC  5 pins	<p>Port E</p>	Hi-Z

Pin	Circuit format	When reset
PE5/PWM0 1 pin	<p>Port E</p>	High level
PE6/TO/ADJ 1 pin	<p>Port E</p> <p>*1 Pull-up transistors approx. 150kΩ. *2 ADJ signals are frequency divider outputs for 32kHz oscillation frequency adjustment. ADJ2K provides usage as buzzer output.</p>	High level (with approx. 150kΩ resistor when reset)
PH0/PWM1 1 pin	<p>Port H</p> <p>* Pull-up transistors approx. 100kΩ</p>	Hi-Z

Pin	Circuit format	When reset
PD0 to PD7 PF0 to PF7  24 pins	<p>Port D Port F</p> <p>PD7 to PD4 by a bit unit PD3 to PD0 by 4-bit unit PF7 to PF0 by 4-bit unit</p> <p>Segment output (VDD level)</p>	
SEG0 to SEG15  16 pins	<p>Segment</p> <p>VDD level</p>	
COM0 to COM3  4 pins	<p>Common</p> <p>VDD level</p>	
VL  1 pin	<p>LCD control (DSP bit)</p> <p>"0" when reset</p> <p>Hi-Z</p>	

Pin	Circuit format	When reset
EXTAL XTAL 2 pins	<ul style="list-style-type: none"> <li>Diagram shows circuit composition during oscillation.</li> <li>Feedback resistor is removed during stop, and XTAL becomes "High" level.</li> </ul>	Oscillation
TEX TX 2 pins	<ul style="list-style-type: none"> <li>Diagram shows circuit composition during oscillation.</li> <li>When the operation of the oscillation circuit is stopped by the software, the feedback resistor is removed and TEX and TX become "Low" level and "High" level respectively.</li> </ul>	Oscillation
<u>RST</u> 1 pin	<p>Mask option</p> <p>Pull-up resistor</p> <p>OP</p> <p>Schmitt input</p>	Low level

**Absolute Maximum Ratings**(V<sub>ss</sub> = 0V reference)

Item	Symbol	Rating	Unit	Remarks
Supply voltage	V <sub>DD</sub>	-0.3 to +7.0	V	
LCD bias voltage	V <sub>LC1</sub> , V <sub>LC2</sub> , V <sub>LC3</sub>	-0.3 to +7.0*1	V	
Input voltage	V <sub>IN</sub>	-0.3 to +7.0*1	V	
Output voltage	V <sub>OUT</sub>	-0.3 to +7.0*1	V	
High level output current	I <sub>OH</sub>	-5	mA	Output (value per pin)
High level total output current	$\Sigma I_{OH}$	-50	mA	Total for all output pins
Low level output current	I <sub>OL</sub>	15	mA	All pins excluding large current output (value per pin)
	I <sub>OLC</sub>	20	mA	Large current outputs (value per pin*2)
Low level total output current	$\Sigma I_{OL}$	100	mA	Total for all output pins
Operating temperature	T <sub>OPR</sub>	-20 to +75	°C	
Storage temperature	T <sub>STG</sub>	-55 to +150	°C	
Allowable power dissipation	P <sub>D</sub>	600	mW	QFP-80P-L01
		380	mW	LQFP-80P-L01
		380	mW	QFP-80P-L03

\*1 V<sub>IN</sub> and V<sub>OUT</sub> must not exceed V<sub>DD</sub> + 0.3V.

\*2 The large current drive transistor is the N-ch transistor of Port C (PC).

**Note)** Usage exceeding absolute maximum ratings may permanently impair the LSI. Normal operation should be conducted under the recommended operating conditions. Exceeding these conditions may adversely affect the reliability of the LSI.

**Recommended Operating Conditions** (Vss = 0V reference)

Item	Symbol	Min.	Max.	Unit	Remarks
Supply voltage	VDD	4.5	5.5	V	High-speed mode guaranteed operation range <sup>*1</sup>
		3.5	5.5		Low-speed mode guaranteed operation range <sup>*1</sup>
		2.7	5.5		Guaranteed operation range with TEX clock
		2.5	5.5		Guaranteed data hold range during STOP
LCD bias voltage	VLC1	Vss	VDD	V	LCD power supply range <sup>*5</sup>
	VLC2				
	VLC3				
High level input voltage	VIH	0.7VDD	VDD	V	*2
	VIHS	0.8VDD	VDD	V	Hysteresis input <sup>*3</sup>
	VIHEx	VDD - 0.4	VDD + 0.3	V	EXTAL <sup>*4</sup>
Low level input voltage	VIL	0	0.3VDD	V	*2
	VILS	0	0.2VDD	V	Hysteresis input <sup>*3</sup>
	VILEX	-0.3	0.4	V	EXTAL <sup>*4</sup>
Operating temperature	Topr	-20	+75	°C	

\*1 High-speed mode is 1/2 frequency divider clock selection; low-speed mode is 1/16 frequency divider clock selection.

\*2 Value for each pin of normal input ports (PA, PB4, PB7, PC and PH0).

\*3 Value of the following pins: RST, CS0, CS1, SI0, SI1, SCK0, SCK1, EC/INT0, INT1, INT2, NMI/INT3, and RMC.

\*4 Specifies only during external clock input.

\*5 Optimal values are determined by LCD used.

**Electrical Characteristics****DC Characteristics**

(Ta = -20 to +75°C, Vss = 0V reference)

Item	Symbol	Pins	Conditions	Min.	Typ.	Max.	Unit
High level output current	VOH	PA, PB, PC, PD*1, PE5, PE6, PF, PH0, VL (VOL only)	VDD = 4.5V, IOH = -0.5mA	4.0			V
			VDD = 4.5V, IOH = -1.2mA	3.5			V
Low level output current	VOL	PC	VDD = 4.5V, IOL = 1.8mA			0.4	V
			VDD = 4.5V, IOL = 3.6mA			0.6	V
			VDD = 4.5V, IOL = 12.0mA			1.5	V
Input current	I <sub>H</sub> E	EXTAL	VDD = 5.5V, VIH = 5.5V	0.5		40	V
	I <sub>L</sub> E		VDD = 5.5V, Vil = 0.4V	-0.5		-40	μA
	I <sub>H</sub> T	TEX	VDD = 5.5V, VIH = 5.5V	0.1		10	μA
	I <sub>L</sub> T			-0.1		-10	μA
	I <sub>H</sub> R	RST*2	VDD = 5.5V, VIL = 0.4V	-1.5		-400	mA
	I <sub>L</sub> R					-45	μA
	I <sub>H</sub> L	PA to PC*3, PH*3, PE0 to PE4, RST*2	VDD = 4.5V, VIH = 4.0V	-2.78			μA
	I <sub>L</sub> L		VDD = 5.5V, VI = 0, 5.5V			±10	μA
I/O leakage current	I <sub>z</sub>	R <sub>COM</sub> SEG0 to SEG15, SEG16 to SEG31*1	COM0 to COM3	VDD = 5V, VLC1 = 3.75V VLC2 = 2.5V VLC3 = 1.25V		3	kΩ
Common output impedance	R <sub>COM</sub>					5	kΩ
Segment output impedance	R <sub>SEG</sub>					5	15
Supply current*4	I <sub>DD</sub> 1	V <sub>DD</sub>	High-speed mode operation (1/2 frequency divider clock)	VDD = 5.5V, 10MHz crystal oscillation (C <sub>1</sub> = C <sub>2</sub> = 15pF)	18	40	mA
	I <sub>DD</sub> 2					35	100
	I <sub>DDS</sub> 1		SLEEP mode	VDD = 5.5V, 10MHz crystal oscillation (C <sub>1</sub> = C <sub>2</sub> = 15pF)	1.1	8	mA
	I <sub>DDS</sub> 2					9	30
	I <sub>DDS</sub> 3		STOP mode	VDD = 5.5V termination of 10MHz and 32kHz crystal oscillation		10	μA

Item	Symbol	Pins	Conditions	Min.	Typ.	Max.	Unit
Input capacity	C <sub>IN</sub>	PA to PC, PE1 to PE4, <u>EXTAL</u> , <u>TEX</u> , <u>RST</u>	Clock 1MHz 0V for all pins excluding measured pins		10	20	pF

\*<sup>1</sup> Common pins of PD0/SEG16 to PD7/SEG23, PF0/SEG24, PF7/SEG31, PD and PF are the case when the common pin is selected as port; SEG16 to SEG31 is when the common pin is selected as segment output.

\*<sup>2</sup> RST specifies the input current when pull-up resistor has been selected; leakage current when no resistor has been selected.

\*<sup>3</sup> PA to PC, and PH0 specify the input current when pull-up resistor has been selected; leakage current when no resistor has been selected. (PE0 to PE4 specify the leakage current.)

\*<sup>4</sup> When all output pins are left open.

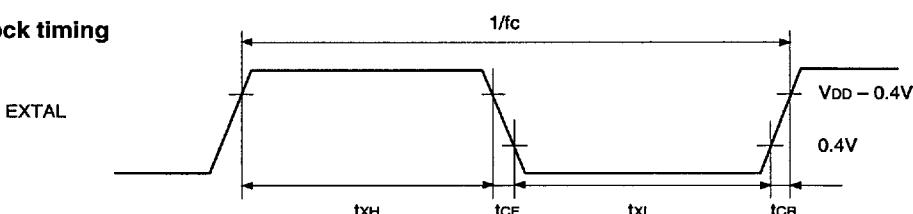
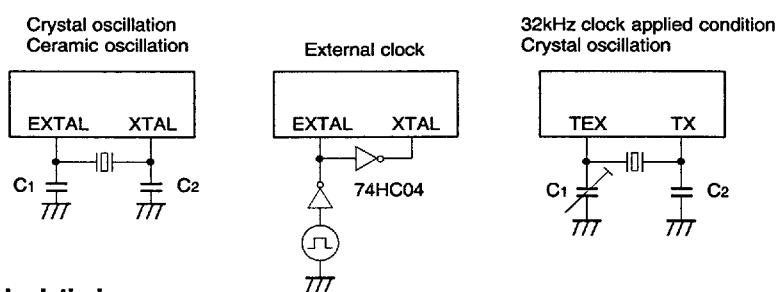
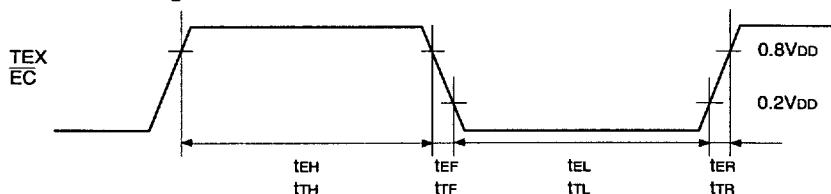
**AC Characteristics****(1) Clock timing**

(Ta = -20 to +75°C, VDD = 4.5 to 5.5V, Vss = 0V reference)

Item	Symbol	Pin	Conditions	Min.	Typ.	Max.	Unit
System clock frequency	fc	XTAL EXTAL	Fig. 1, Fig. 2	1		10	MHz
System clock input pulse width	t <sub>XL</sub> , t <sub>XH</sub>	EXTAL	Fig. 1, Fig. 2 External clock drive	37.5			ns
System clock input rise and fall time	t <sub>CR</sub> , t <sub>CF</sub>	EXTAL	Fig. 1, Fig. 2 External clock drive			200	ns
Event count input clock pulse width	t <sub>EH</sub> , t <sub>EL</sub>	EC	Fig. 3	t <sub>sys</sub> + 50*			ns
Event count input clock rise and fall time	t <sub>ER</sub> , t <sub>EF</sub>	EC	Fig. 3			20	ms
System clock frequency	fc	TEX TX	VDD = 2.7 to 5.5V Fig. 2 (32kHz clock applied condition)		32.768		kHz
Event count input clock input pulse width	t <sub>TL</sub> , t <sub>TH</sub>	TEX	Fig. 3	10			μs
Event count input clock rise and fall time	t <sub>TR</sub> , t <sub>TF</sub>	TEX	Fig. 3			20	ms

\* t<sub>sys</sub> indicates the three values below according to the upper two bits (CPU clock selection) of the clock control register (CLC: 00FEH).

t<sub>sys</sub> (ns) = 2000/fc (upper two bits = "00"), 4000/fc (upper two bits = "01"), 16000/fc (upper two bits = "11")

**Fig. 1. Clock timing****Fig. 2. Clock applied conditions****Fig. 3. Event count clock timing**

## (2) Serial transfer

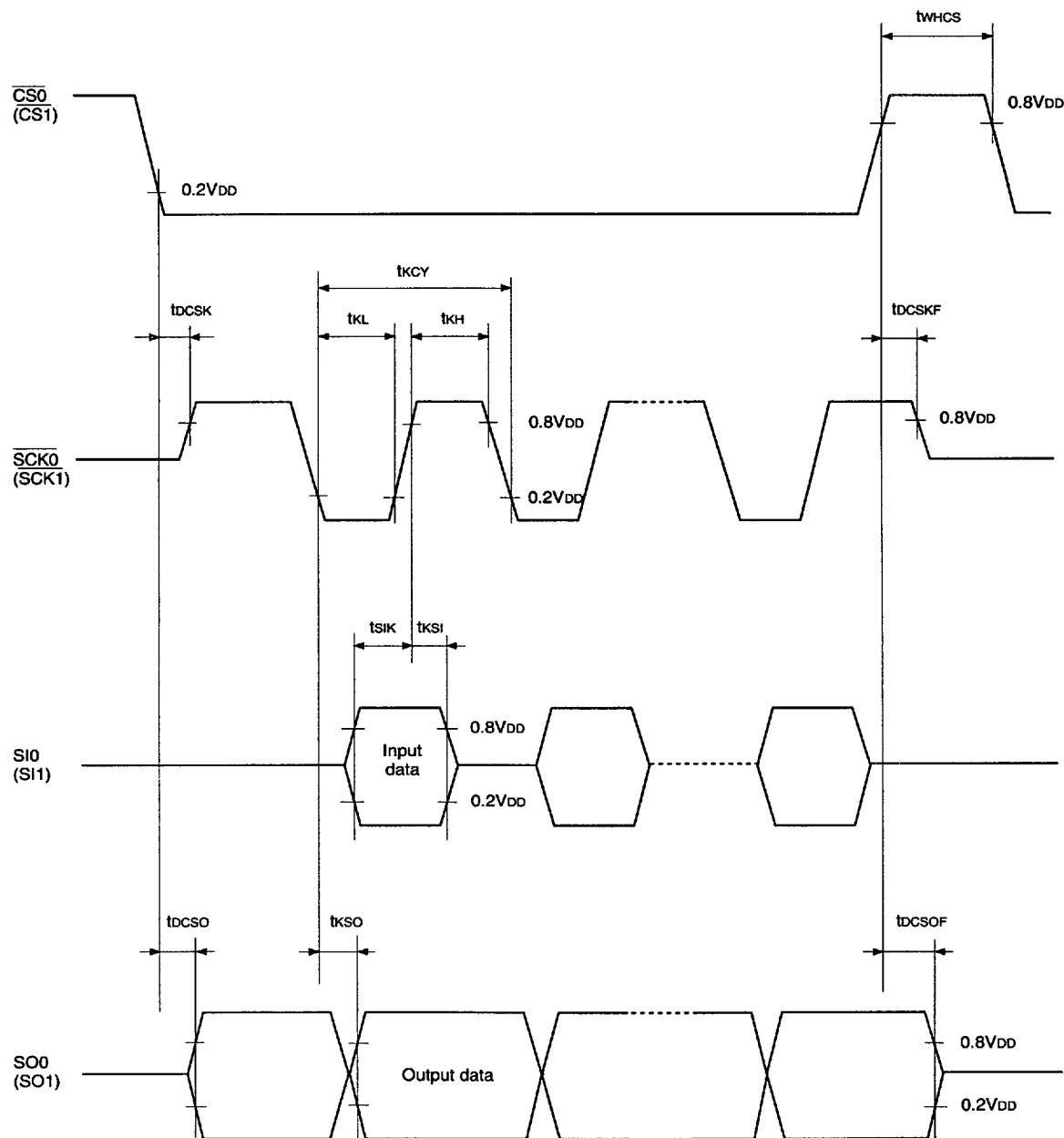
(Ta = -20 to +75°C, VDD = 4.5 to 5.5V, Vss = 0V reference)

Item	Symbol	Pin	Conditions	Min.	Max.	Unit
CS0 ↓ → SCK0 (CS1 ↓ → SCK1) delay time	t <sub>DCSK</sub>	SCK0 (SCK1)	Chip select transfer mode (SCK0 (SCK1) = output mode)		t <sub>sys</sub> + 20	ns
CS0 ↑ → SCK0 (CS1 ↑ → SCK1) floating delay time	t <sub>DCSKF</sub>	SCK0 (SCK1)	Chip select transfer mode (SCK0 (SCK1) = output mode)		t <sub>sys</sub> + 20	ns
CS0 ↓ → SO0 (CS1 ↓ → SO1) delay time	t <sub>DCSO</sub>	SO0 (SO1)	Chip select transfer mode		t <sub>sys</sub> + 20	ns
CS0 ↑ → SO0 (CS1 ↑ → SO1) floating delay time	t <sub>DCSOF</sub>	SO0 (SO1)	Chip select transfer mode		t <sub>sys</sub> + 20	ns
CS0 (CS1) high level width	t <sub>WHCS</sub>	CS0 (CS1)	Chip select transfer mode	t <sub>sys</sub> + 200		ns
SCK0 (SCK1) cycle time	t <sub>KCY</sub>	SCK0 (SCK1)	Input mode	2t <sub>sys</sub> + 200		ns
			Output mode	16000/fc		ns
SCK0 (SCK1) high and low level widths	t <sub>KH</sub> t <sub>KL</sub>	SCK0 (SCK1)	Input mode	t <sub>sys</sub> + 100		ns
			Output mode	8000/fc - 50		ns
SI0 (SI1) input setup time (for SCK0↑ (SCK1↑))	t <sub>SIK</sub>	SI0 (SI1)	SCK0 (SCK1) input mode	100		ns
			SCK0 (SCK1) output mode	200		ns
SI0 (SI1) input hold time (for SCK0↑ (SCK1↑))	t <sub>SKI</sub>	SI0 (SI1)	SCK0 (SCK1) input mode	t <sub>sys</sub> + 200		ns
			SCK0 (SCK1) output mode	100		ns
SCK0 ↓ → SO0 (SCK1 ↓ → SO1) delay time	t <sub>KSO</sub>	SO0 (SO1)	SCK0 (SCK1) input mode		t <sub>sys</sub> + 200	ns
			SCK0 (SCK1) output mode		100	ns

**Note 1)** t<sub>sys</sub> indicates the three values below according to the upper two bits (CPU clock selection) of the clock control register (CLC: 00FEH).

t<sub>sys</sub> (ns) = 2000/fc (upper two bits = "00"), 4000/fc (upper two bits = "01"), 16000/fc (upper two bits = "11")

**Note 2)** The load condition for the SCK0 (SCK1) output mode, SO0 (SO1) output delay time is 50pF + 1TTL.

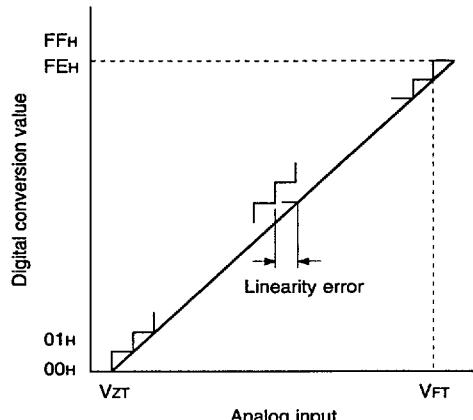
**Fig. 4. Serial transfer CH0 timing**

## (3) A/D converter characteristics

(Ta = -20 to +75°C, V<sub>DD</sub> = 4.5 to 5.5V, AV<sub>REF</sub> = 4.0 to AV<sub>DD</sub>, V<sub>SS</sub> = 0V reference)

Item	Symbol	Pin	Conditions	Min.	Typ.	Max.	Unit
Resolution						8	Bits
Linearity error						±3	LSB
Zero transition voltage	V <sub>ZT</sub> *1		Ta = 25°C V <sub>DD</sub> = 5.0V V <sub>SS</sub> = 0V	-10	10	70	mV
Full-scale transition voltage	V <sub>FT</sub> *2			4910	4970	5030	mV
Conversion time	t <sub>CONV</sub>			160/f <sub>ADC</sub> *3			μs
Sampling time	t <sub>SAMP</sub>			12/f <sub>ADC</sub> *3			μs
Analog input voltage	V <sub>IAN</sub>	AN0 to AN7		0		V <sub>DD</sub> + 0.3	V

Fig. 5. Definition of A/D converter terms



\*1 V<sub>ZT</sub>: Value atwhich the digital conversion value changes from 00H to 01H and vice versa.

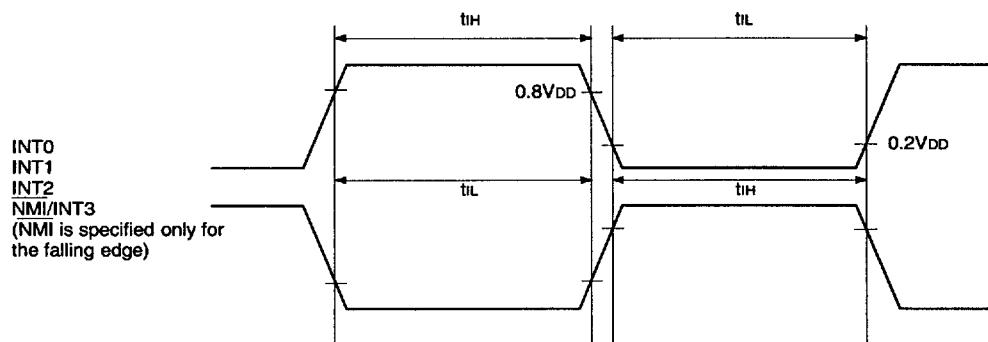
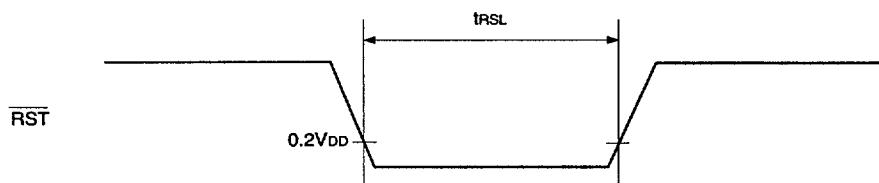
\*2 V<sub>FT</sub>: Value at which the digital conversion value changes from FEH to FFH and vice versa.

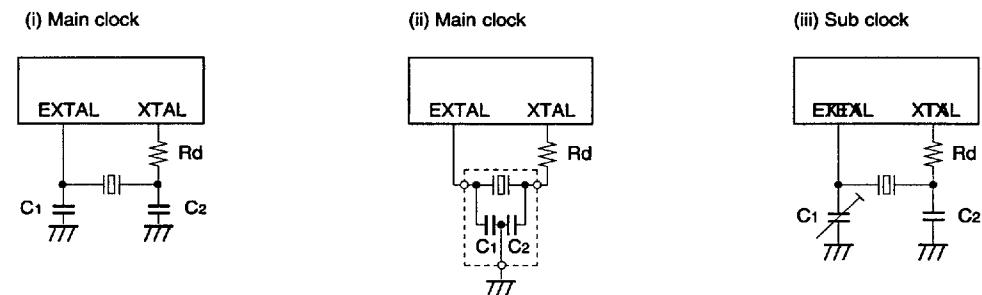
\*3 f<sub>ADC</sub> indicates the below values due to the contents of bit 6 (CK3) of the A/D control register (ADC: 00F9H) and bit 7 (PCK1) and bit 6 (PCK0) of the clock control resistor (CLC: 00FEH).

CKS PCK1, PCK0	0 (φ/2 selection)	0 (φ selection)
00 (φ = f <sub>EX</sub> /2)	f <sub>ADC</sub> = f <sub>c</sub> /2	f <sub>ADC</sub> = f <sub>c</sub>
01 (φ = f <sub>EX</sub> /4)	f <sub>ADC</sub> = f <sub>c</sub> /4	f <sub>ADC</sub> = f <sub>c</sub> /2
11 (φ = f <sub>EX</sub> /16)	f <sub>ADC</sub> = f <sub>c</sub> /16	f <sub>ADC</sub> = f <sub>c</sub> /8

## (4) Interruption, reset input (Ta = -20 to +75°C, VDD = 4.5 to 5.5V, Vss = 0V reference)

Item	Symbol	Pin	Conditions	Min.	Max.	Unit
External interruption high and low level widths	$t_{IH}$ $t_{IL}$	INT0 INT1 INT2 NMI/INT3		1		μs
Reset input low level width	$t_{RSL}$	RST		32/fc		μs

**Fig 6. Interruption input timing****Fig. 7.  $\overline{RST}$  input timing**

**Appendix****Fig. 8. SPC700 Series recommended oscillation circuit**

Manufacturer	Model	fc (MHz)	C1 (pF)	C2 (pF)	Rd ( $\Omega$ )	Circuit example	
MURATA MFG CO., LTD.	CSA4.19MG	4.19	30	30	0	(i)	
	CSA8.00MG	8.00					
	CSA10.0MT	10.00					
	CST4.19MGW*	4.19				(ii)	
	CST8.00MTW*	8.00					
	CST10.00MTW*	10.00					
RIVER ELETEC CO., LTD.	HC-49/U03	4.19	15	15	2.2k	(i)	
		8.00					
		10.00					
KINSEKI LTD.	HC-49/U (-S)	4.19	22	22	560	(i)	
		8.00	18	18	0		
		10.00					

Models with an asterisk (\*) have the built-in ground capacitance (C<sub>1</sub>, C<sub>2</sub>).

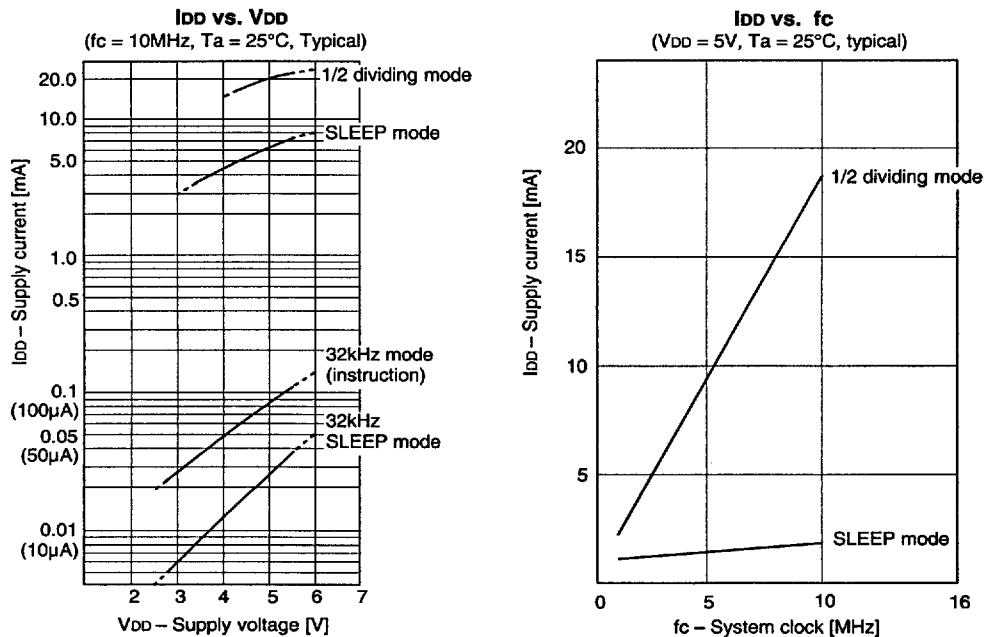
**Mask Option Table**

Item	Content	
Reset pin pull-up resistor	Non-existent	Existen

**Package Table**

Product name	Package
CXP83412/83416	80-pin plastic QFP/LQFP
CXP83413/83417	80-pin plastic QFP (0.65mm pitch)

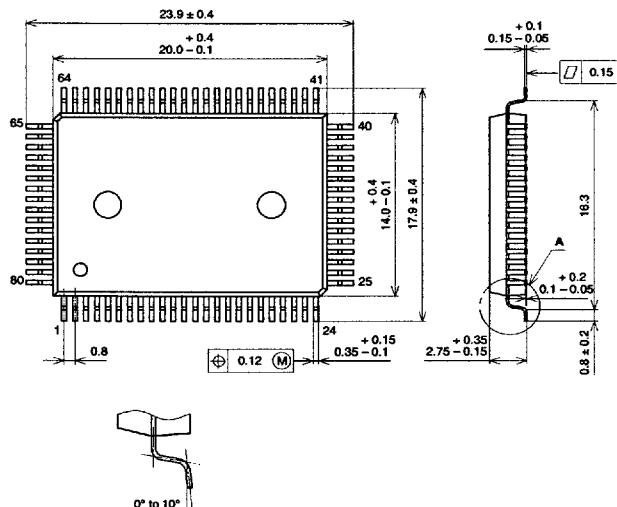
## Characteristic Curves



Package Outline      Unit : mm

CXP83412/83416

80PIN QFP (PLASTIC)



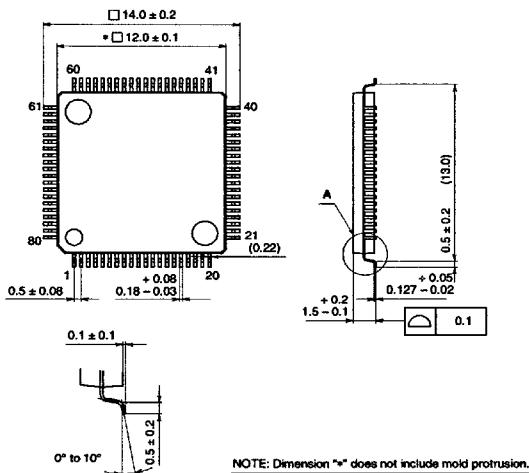
SONY CODE	QFP-80P-L01
EIAJ CODE	•QFP80-P-1420-A
JEDEC CODE	—

## PACKAGE STRUCTURE

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	COPPER / 42 ALLOY
PACKAGE WEIGHT	1.6g

## CXP83412/83416

80PIN LQFP (PLASTIC)



## DETAIL A

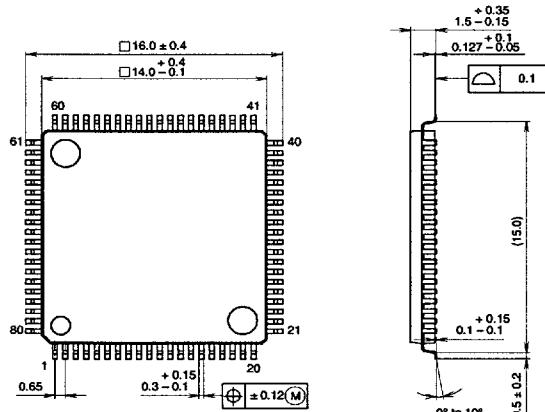
## PACKAGE STRUCTURE

SONY CODE	LQFP-80P-L01
EIAJ CODE	+QFP080-P-1212-A
JEDEC CODE	-----

PACKAGE MATERIAL	EPOXY / PHENOL RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	42 ALLOY
PACKAGE WEIGHT	0.5g

## CXP83413/83417

80PIN QFP (PLASTIC)



## PACKAGE STRUCTURE

SONY CODE	QFP-80P-L03
EIAJ CODE	LQFP080-P-1414
JEDEC CODE	-----

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	COPPER / 42 ALLOY
PACKAGE WEIGHT	0.6g